FEATURES AND SPECIFICATIONS

查询"48206-0104"供应商

Molex offers the Fully Buffered DIMM with color options for server applications.

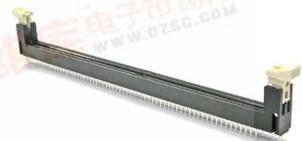
The development of Fully Buffered DIMM (FB DIMM) came from the need for larger and faster memory capacity where memory coordination and accuracy at high speeds are critical which DDR2 is not capable of supporting.

The FB DIMM is a variant of the DDR2. It combines the high-speed internal architecture of DDR2 with a bi-directional point-to-point serial memory interface which links each FB DIMM module together in a chain. The difference is here in which the DDR2 uses a single memory bus.

Molex is an active member of the JEDEC work group that defines industry standards for memory. This allows Molex to ensure that all our memory sockets are 100% industry compatible.



<mark>48206</mark> Vertical, Through Hole



Features	Benefits
High-temperature thermoplastic housing	Lead-free process compatible
 Accepts JEDEC defined module MO-256 Complies with JEDEC SO-003 socket specifications 	• Ensures 100% industry compatibility
Dual ejector latches	 Ensures easy module insertion and removal with minimal micro motion
Built in end key design	Ensures correct insertion of FB memory module
• Latch tower support	Aids in keeping the module vertical
Beveled metal pins (forklocks)	 Provides proper socket to PCB alignment and retention, during and after soldering

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SPECIIFICATIONS

Reference Information

Packaging: Tray
UL File No.: TBD
CSA File No.:TBD

Mates With: JEDEC MO-256 memory modules Complies with: JEDEC SO-003 Socket Outline

Designed In: Millimeters

Electrical Voltage: 30V Current: 0.5A

Contact Resistance: 20 milliohms max
Dielectric Withstanding Voltage: 500V AC
Insulation Resistance: 1000 Megohms min

Mechanical

Contact retention to housing: 3N min (Contact)

13N min (Forklock)

Insertion Force to PCB: 0.56N (0.13lb)

Mating Force: 0.81N (0.18lb) Unmating Force: 0.02N (0.01lb)

Latch Actuation Force: 45N max per latch

Durability: 10 Cycles

Physical

Housing: See order table Flammability rating: UL 94V-0 Contact: Copper (Cu) Alloy PCB thickness: 1.60mm (.062")

Plating:

Contact Area — See order table Solder Tail Area — Tin (Sn), Lead-free

Underplating — Nickel

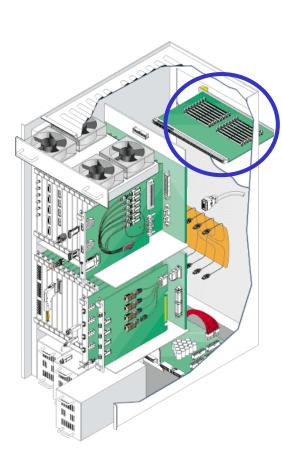
Operating Temperature: +260°C max.



MARKETS AND APPLICATIONS

查询"48206-0104"供应商

- Computing
 - High-end workstations
- Servers
 - Blade servers
 - Rack-optimized servers
 - Mainframe
- **■** Telecommunications
 - Routers
 - Switches



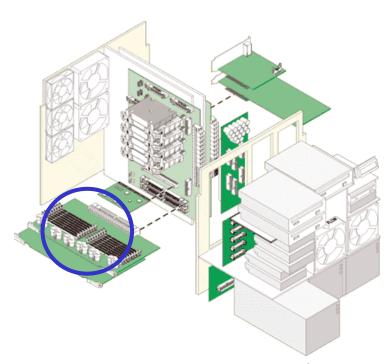
Telecommunications Router



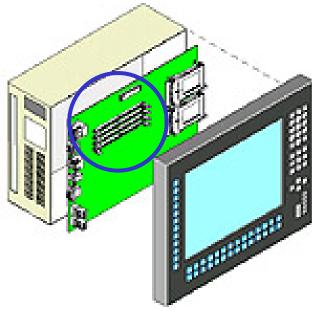
1.00mm (.039") Pitch
Fully Buffered DIMM Socket 240 Circuit With Color Options

48206

Vertical, Through Hole



Server



High-end Workstation



48206 Vertical, Through Hole

Description	Lead-Free	Features					
Description	Ordering	Plating	Solder Tail Length	Latch Color	Housing	Recommended PCB Thickness	
FB DIMM Socket, Vertical, with Beveled Metal Pins, 1.8V Center	48206-0001	0.38µm (15µ") Gold (Au)	2.67mm (.105")	White	Nylon 4/6, Black	1.60mm (.062")	
	48206-0002	0.76μm (30μ") Gold (Au)	2.0711111 (.100)				
	48206-0003	0.38µm (15µ") Gold (Au)	3.18mm (.125")				
	48206-0004	0.76μm (30μ") Gold (Au)	3.1011111 (.123)				
	48206-0005	Gold (Au) Flash	2.67mm (.105")				
	48206-0006	Gold (Au) Flash	3.18mm (.125")				
	48206-0101	0.38µm (15µ") Gold (Au)	2.67mm (.105")		Nylon 4/6, Black	1.60mm (.062")	
	48206-0102	0.76μm (30μ") Gold (Au)	2.67mm (.105")	Black			
	48206-0103	0.38µm (15µ") Gold (Au)	3.18mm (.125")				
	48206-0104	0.76µm (30µ") Gold (Au)	3.18mm (.125")				
	48206-0105	Gold (Au) Flash	2.67mm (.105")				
	48206-0106	Gold (Au) Flash	3.18mm (.125")				
	48206-9001	0.38µm (15µ") Gold (Au)	2.67mm (.105")	White	Nylon 6/6, Blue	1.60mm (.062")	
	48206-9002	0.76µm (30µ") Gold (Au)	2.67mm (.105")				
	48206-9003	0.38µm (15µ") Gold (Au)	3.18mm (.125")				
	48206-9004	0.76μm (30μ") Gold (Au)	3.18mm (.125")				
	48206-9005	Gold (Au) Flash	2.67mm (.105")				



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Americas Headquarters 2222 Wellington Ct. Lisle, Illinois 60532 USA 1-800-78MOLEX amerinfo@molex.com Far East North Headquarters Yamato, Kanagawa, Japan 81-462-65-2324 feninfo@molex.com Far East South Headquarters Jurong, Singapore 65-6-268-6868 fesinfo@molex.com European Headquarters Munich, Germany 49-89-413092-0 eurinfo@molex.com Corporate Headquarters 2222 Wellington Ct. Lisle, Illinois 60532 USA 630-969-4550